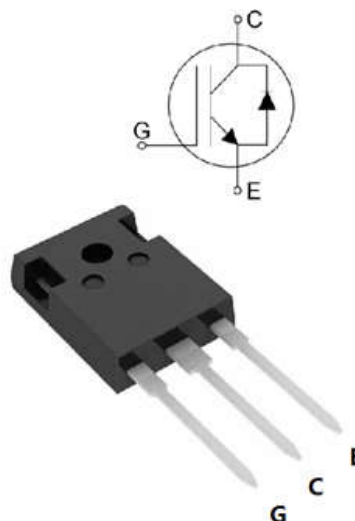


FEATURES

- High breakdown voltage to 1200V for improved reliability
- Trench-Stop Technology offering :
 - very tight parameter distribution
 - high ruggedness, temperature stable behavior
 - Short circuit withstand time – 10μs
 - High ruggedness, temperature stable
 - Low $V_{CE(SAT)}$
 - Easy parallel switching capability due to positive temperature coefficient in $V_{CE(SAT)}$
- Enhanced avalanche capability
- Soft current turn-off waveforms

V_{CE}	1200	V
I_C	20	A
$V_{CE(SAT)} \quad I_C=20A$	1.9	V



APPLICATION

- Inductive cooking
- Inverterized microwave ovens
- Resonant converters
- Soft switching application

Product	Package	Packaging
SPT20N120F1	TO247	Tube



Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-Emitter Breakdown Voltage	V_{CE}	1200	V
DC collector current, limited by T_{jmax} $T_C = 25^{\circ}C$ $T_C = 100^{\circ}C$	I_C	40 20	A
Diode Forward current, limited by T_{jmax} $T_C = 25^{\circ}C$ $T_C = 100^{\circ}C$	I_F	40 20	A
Pulsed collector current, t_p limited by T_{jmax}	I_{Cpuls}	60	A
Turn off safe operating area $V_{CE} \leq 1200V$, $T_j \leq 150^{\circ}C$	-	60	A
Short Circuit Withstand Time, $V_{GE} = 15V$, $V_{CE} \leq 600V$	T_{sc}	10	μs
Power dissipation, $T_j = 25^{\circ}C$	P_{tot}	208	W
Operating junction temperature T_j	-	-40...+150	$^{\circ}C$
Storage temperature	T_s	-55...+150	$^{\circ}C$
Soldering temperature, wave soldering 1.6mm (0.063in.) from case for 10s	-	260	$^{\circ}C$

Thermal Resistance

Parameter	Symbol	Max. Value	Unit
IGBT thermal resistance, junction - case	$R_{\theta(j-c)}$	0.64	K/W
Diode thermal resistance, junction - case	$R_{\theta(j-c)}$	1.5	K/W
Thermal resistance, junction - ambient	$R_{\theta(j-a)}$	40	K/W



Electrical Characteristics of the IGBT ($T_j = 25^\circ\text{C}$ unless otherwise specified) :

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Static						
Collector-Emitter breakdown voltage	BV_{CES}	$V_{GE}=0V, I_C=250\mu A$	1200	-	-	V
Gate threshold voltage	$V_{GE(th)}$	$V_{GE}=V_{CE}, I_C=250\mu A$	5.2	6.0	6.8	V
Collector-Emitter Saturation voltage	$V_{CE(sat)}$	$V_{GE}=15V, I_C=20A$ $T_j = 25^\circ\text{C}$ $T_j = 150^\circ\text{C}$	- -	1.9 2.4	2.3 -	V
Zero gate voltage collector current	I_{CES}	$V_{CE} = 1200V, V_{GE} = 0V$ $T_j = 25^\circ\text{C}$ $T_j = 150^\circ\text{C}$	- -	- -	100 1000	μA
Gate-emitter leakage current	I_{GES}	$V_{CE} = 0V, V_{GE} = 20V$	-	-	100	nA
Transconductance	g_{fs}	$V_{CE}=20V, I_C=20A$	-	13	-	S

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Dynamic						
Input capacitance	C_{ies}	$V_{CE} = 25V, V_{GE} = 0V,$ $f = 1\text{MHz}$	-	1870	-	pF
Output capacitance	C_{oes}		-	72	-	
Reverse transfer capacitance	C_{res}		-	48	-	
Gate charge	Q_G	$V_{CC} = 960V, I_C = 20A,$ $V_{GE} = 15V$	-	140	-	nC
Short circuit collector current	$I_{C(SC)}$	$V_{GE}=15V, t_{SC} \leq 10\mu s$ $V_{CC}=600V,$ $T_{j, start}=25^\circ\text{C}$	-	140	-	A



Switching Characteristic, Inductive Load

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Dynamic , at $T_j = 25^\circ \text{C}$						
Turn-on delay time	$t_{d(on)}$	$V_{CC} = 600V, I_C = 20A,$ $V_{GE} = 0/15V,$ $R_g = 42\Omega$	-	60	-	ns
Rise time	t_r		-	22	-	ns
Turn-on energy	E_{on}		-	2.5	-	mJ
Turn-off delay time	$t_{d(off)}$		-	300	-	ns
Fall time	t_f		-	180	-	ns
Turn-off energy	E_{off}		-	0.43	-	mJ

Electrical Characteristics of the DIODE ($T_j = 25^\circ \text{C}$ unless otherwise specified)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Dynamic						
Diode Forward Voltage	V_{FM}	$I_F = 20A$	-	2.9	-	V
Reverse Recovery Time	T_{rr}	$I_F = 15A,$ $di/dt = 600A/\mu s$	-	270	-	ns
Reverse Recovery Current	I_{rr}		-	10	-	A
Reverse Recovery Charge	Q_{rr}		-	1800	-	nC



Fig. 1 FBSOA characteristics

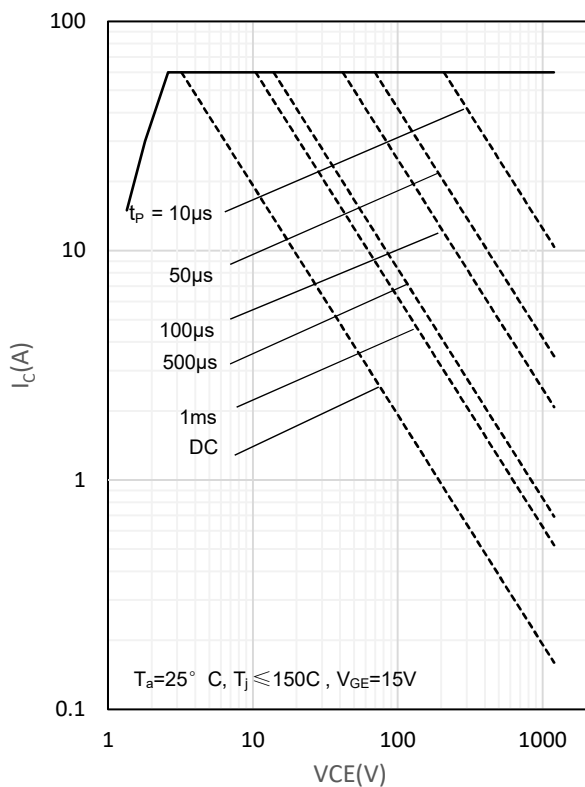


Fig. 2 Load Current vs. Frequency

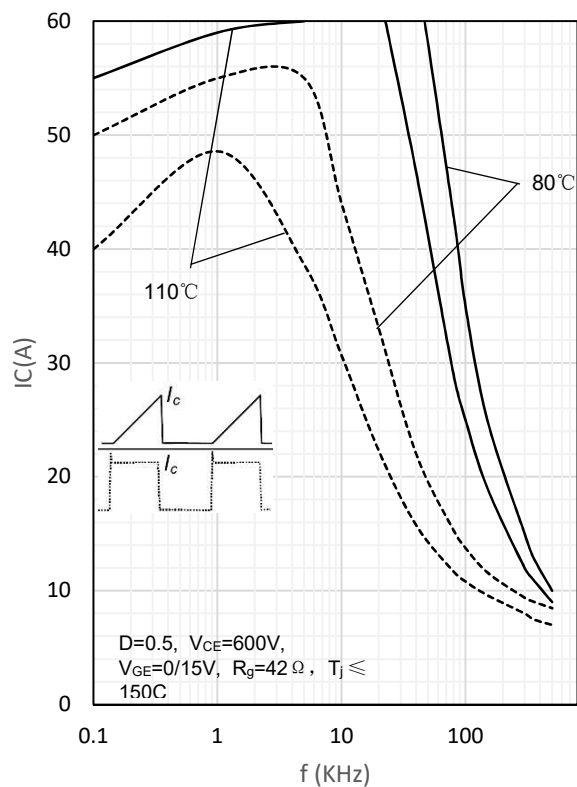


Fig. 3 Output characteristics

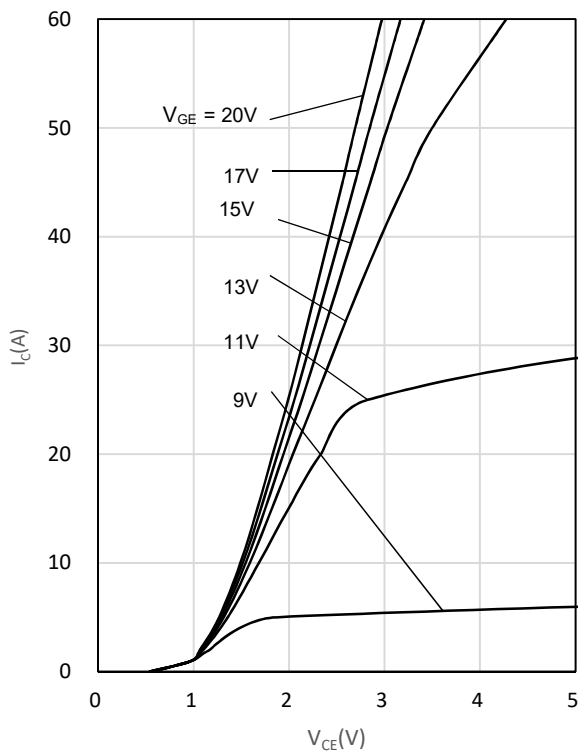


Fig. 4 Saturation voltage characteristics

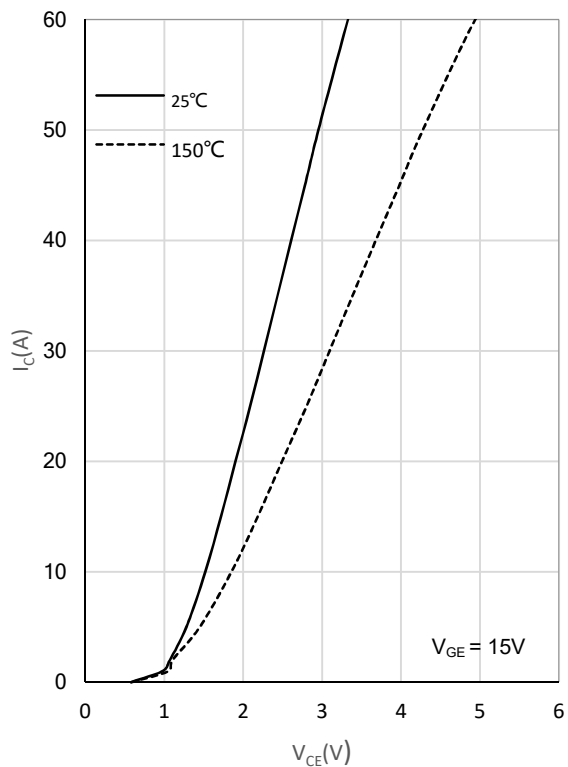




Fig. 5 Switching times vs. gate resistor

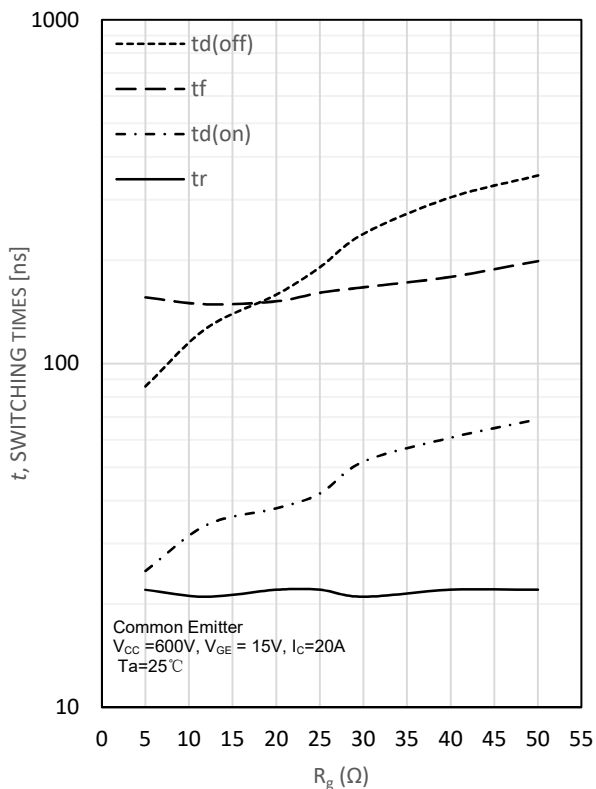


Fig. 6 Switching times vs. collector current

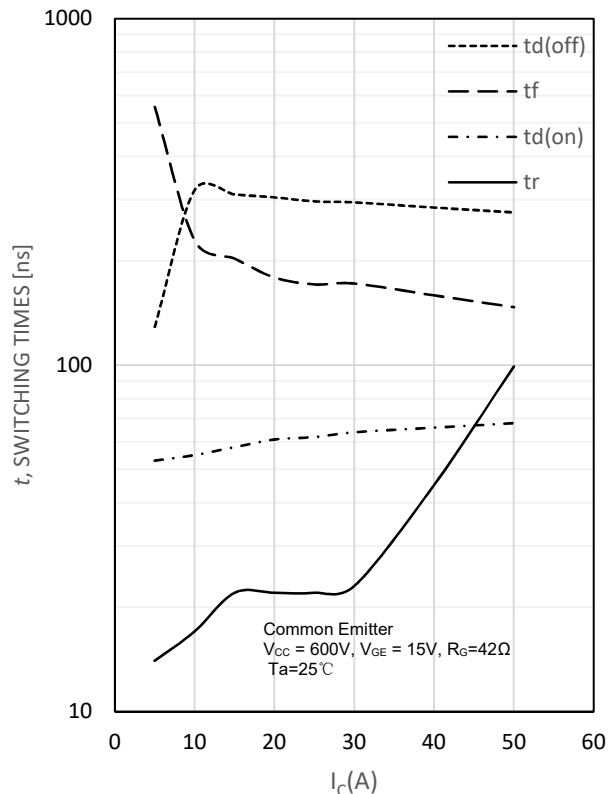


Fig. 7 Switching loss vs. gate resistor

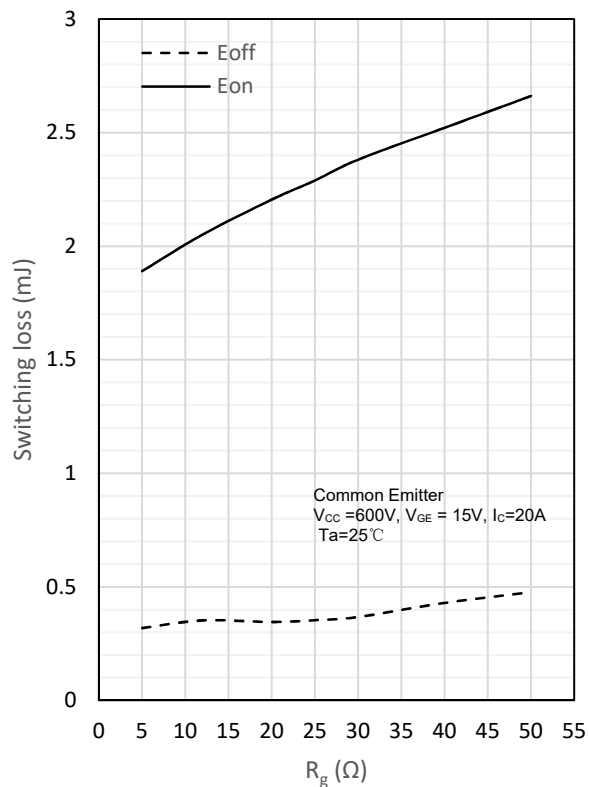


Fig. 8 Switching loss vs. collector current

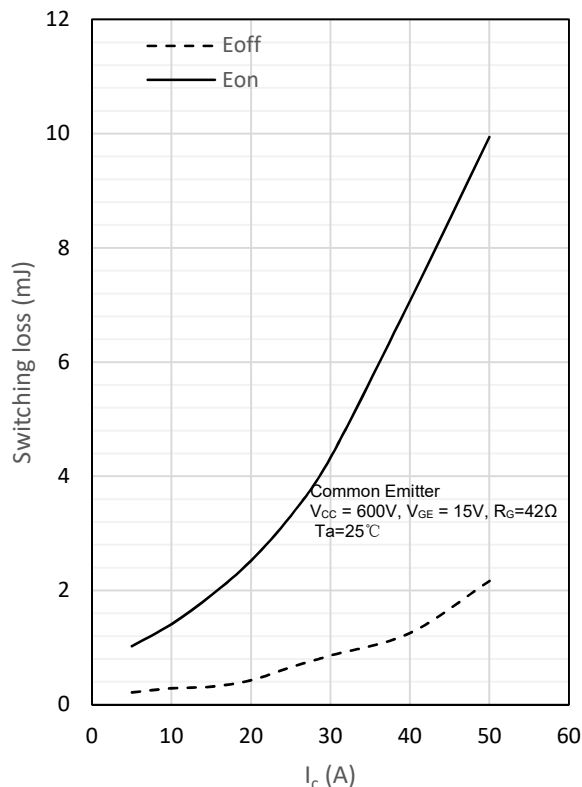




Fig. 9 Gate charge characteristics

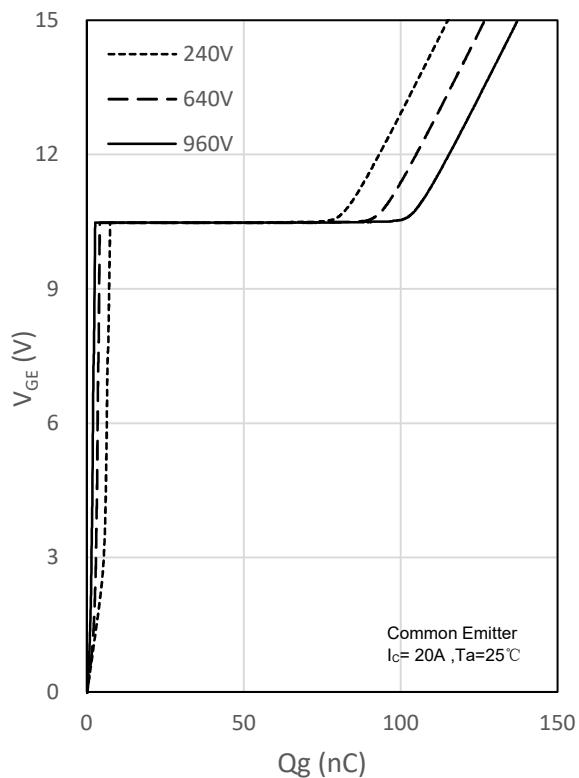
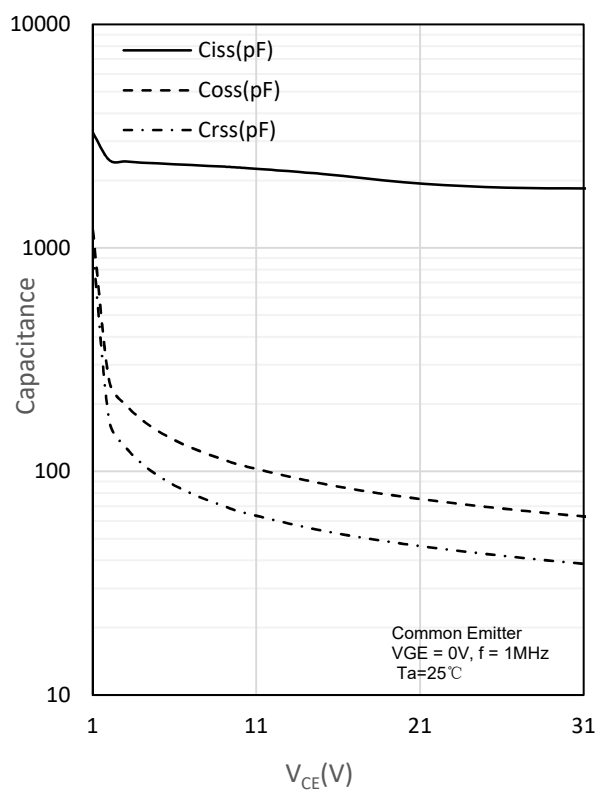
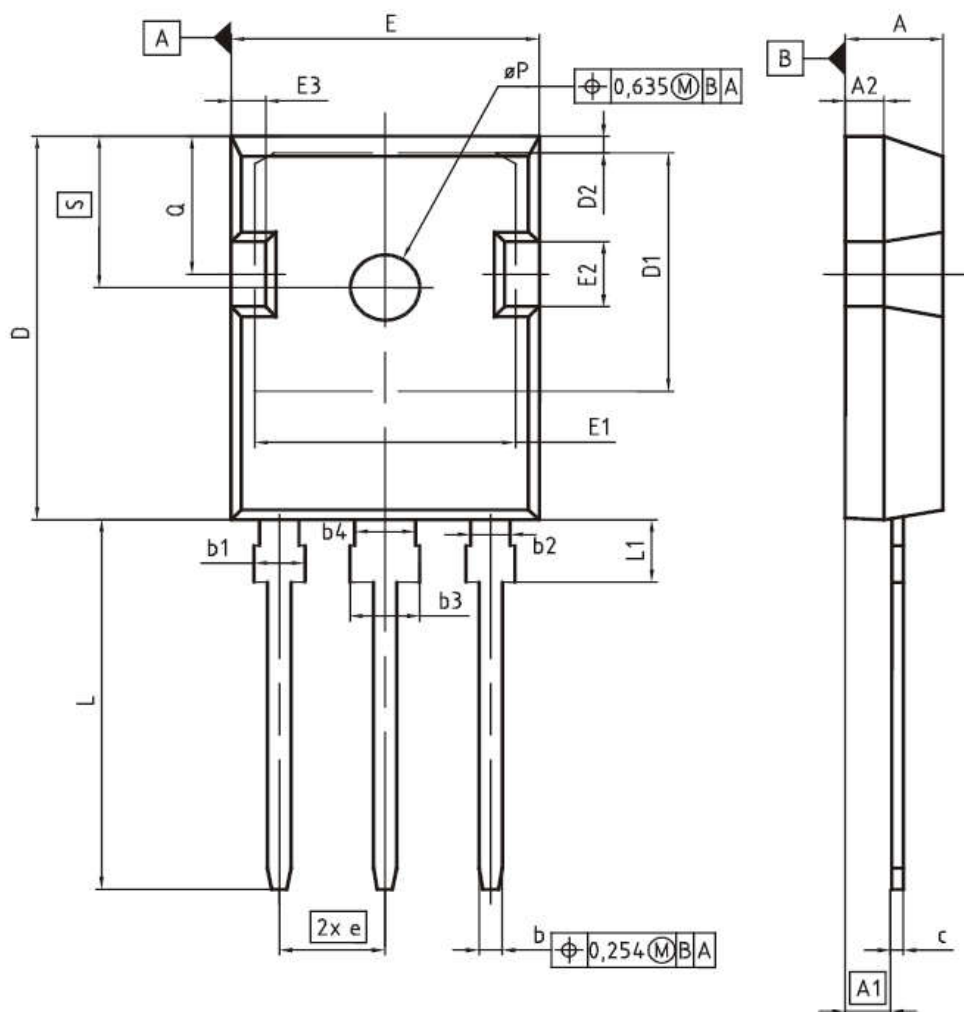


Fig. 10 Capacitance characteristics





PG-TO247-3



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.83	5.21	0.190	0.205
A1	2.27	2.54	0.089	0.100
A2	1.85	2.16	0.073	0.085
b	1.07	1.33	0.042	0.052
b1	1.90	2.41	0.075	0.095
b2	1.90	2.16	0.075	0.085
b3	2.87	3.38	0.113	0.133
b4	2.87	3.13	0.113	0.123
c	0.55	0.68	0.022	0.027
D	20.80	21.10	0.819	0.831
D1	16.25	17.65	0.640	0.695
D2	0.95	1.35	0.037	0.053
E	15.70	16.13	0.618	0.635
E1	13.10	14.15	0.516	0.557
E2	3.68	5.10	0.145	0.201
E3	1.00	2.60	0.039	0.102
e	5.44 (BSC)		0.214 (BSC)	
N	3		3	
L	19.80	20.32	0.780	0.800
L1	4.10	4.47	0.161	0.176
øP	3.50	3.70	0.138	0.146
Q	5.49	6.00	0.216	0.236
S	6.04	6.30	0.238	0.248